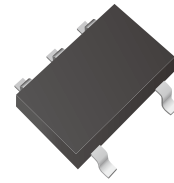
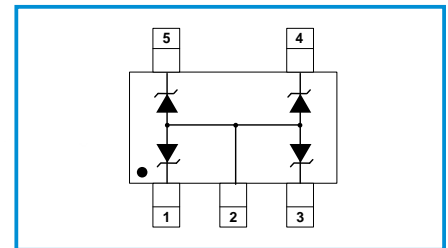


Quad-direction ESD Protection Array

Features

- Uni-directional ESD protection of four lines
- Low reverse stand-off voltage: 5V
- Low reverse clamping voltage
- Low leakage current
- Excellent package: 2.10mm × 1.25mm × 0.96mm
- Fast response time
- JESD22-A114-B ESD Rating of class 3B per human body model
- IEC 61000-4-2 Level 3 ESD protection
- Marking: 12


Functional Diagram


Applications

- Computers and peripherals
- Audio and video equipment
- Cellular handsets and accessories
- Portable electronics
- Other electronics equipments communication systems

Absolute Maximum Ratings (T_{amb}=25°C unless otherwise specified)

Parameter	Symbol	Limit	Unit
IEC 61000-4-2 ESD Voltage	V _{ESD} ⁽¹⁾	±25	kV
Air Model			
Contact Model		±25	
JESD22-A114-B ESD Voltage		±16	
ESD Voltage		±0.4	
Peak Pulse Power	P _{PP} ⁽²⁾	60	W
Peak Pulse Current	I _{PP} ⁽²⁾	5	A
Lead Solder Temperature – Maximum (10 Second Duration)	T _L	260	°C
Junction Temperature	T _j	150	°C
Storage Temperature Range	T _{stg}	-55 ~ +150	°C

(1). Device stressed with ten non-repetitive ESD pulses, Per channel(I/O to GND).

(2). Non-repetitive current pulse 8/20μs exponential decay waveform according to IEC61000-4-5.

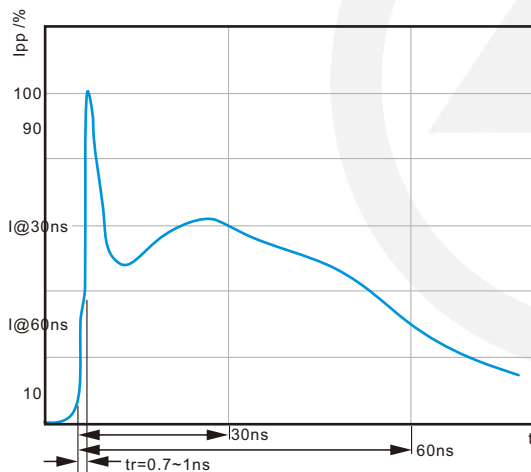
ESD standards compliance

IEC61000-4-2 Standard

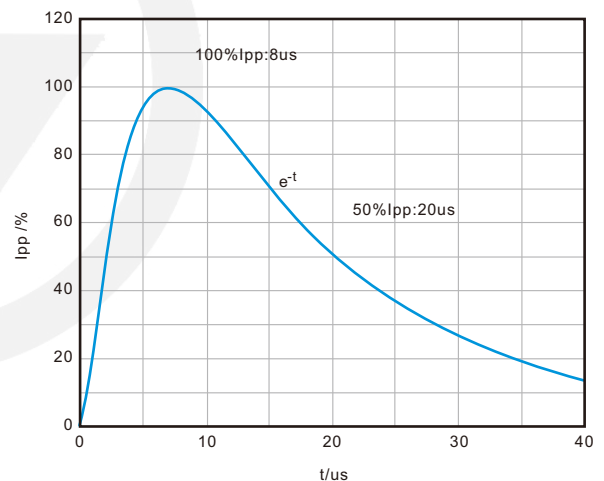
Contact Discharge		Air Discharge	
Level	Test Voltage kV	Level	Test Voltage kV
1	2	1	2
2	4	2	4
3	6	3	8
4	8	4	15

JESD22-A114-B Standard

ESD Class	Human Body Discharge V
0	0~249
1A	250~499
1B	500~999
1C	1000~1999
2	2000~3999
3A	4000~7999
3B	8000~15999



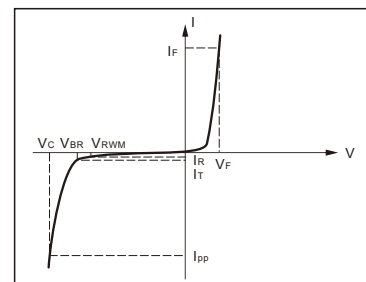
ESD pulse waveform according to IEC61000-4-2



8/20µs pulse waveform according to IEC 61000-4-5

Electrical Parameter

Symbol	Parameter
V_C	Clamping Voltage @ I_{PP}
I_{PP}	Peak Pulse Current
V_{BR}	Breakdown Voltage @ I_T
I_T	Test Current
I_R	Reverse Leakage Current @ V_{RWM}
V_{RWM}	Reverse Standoff Voltage
V_F	Forward Voltage @ I_F
I_F	Forward Current



V-I characteristics for a uni-directional TVS

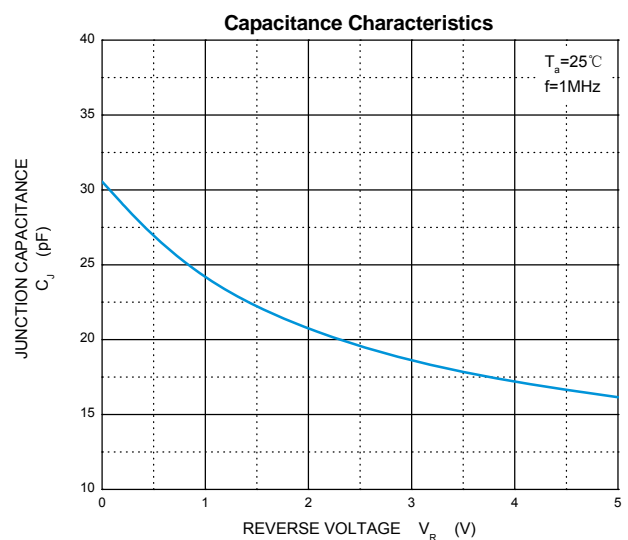
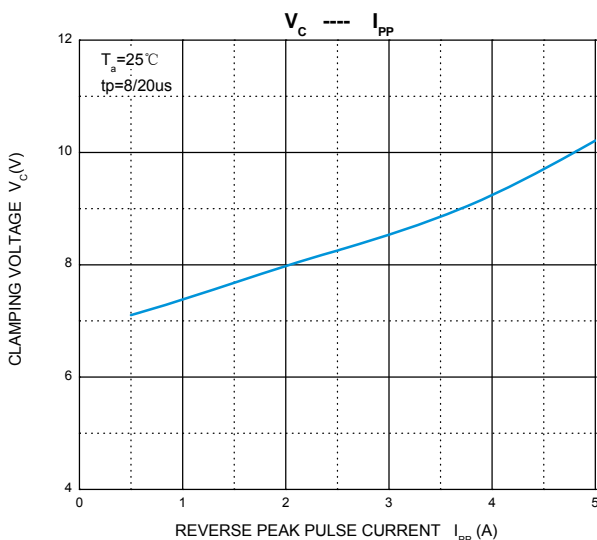
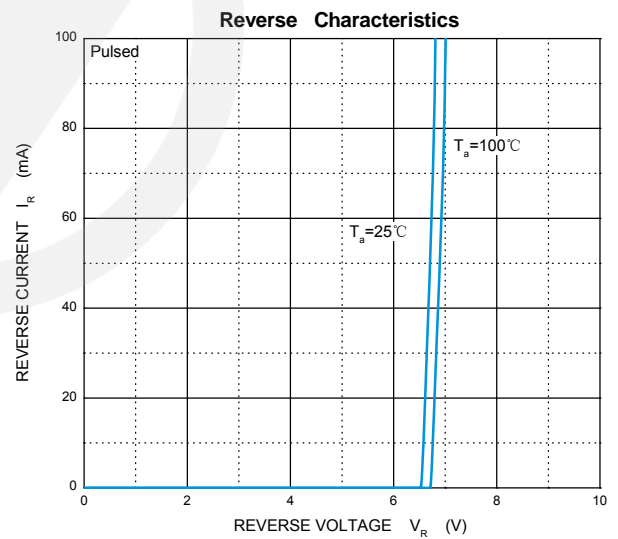
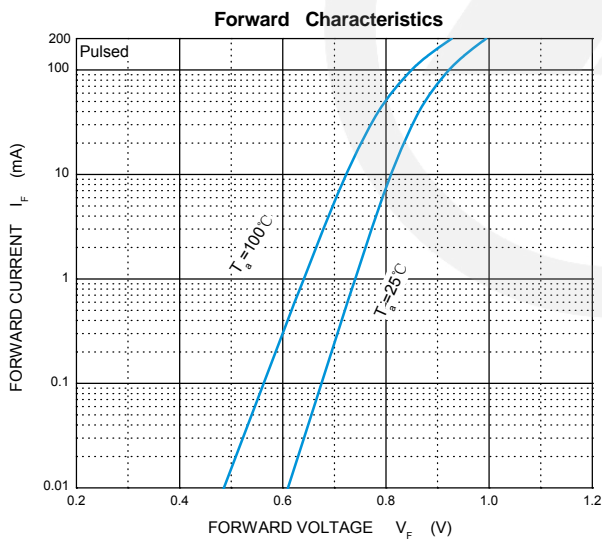
Electrical Characteristics (TA=25°C unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Per Diode						
Reverse stand off voltage	$V_{RWM}^{(1)}$				5	V
Breakdown voltage	$V_{(BR)}$	$I_T=1mA$	6.0		7.2	V
Reverse leakage current	I_R	$V_{RWM}=5V$			5.0	μA
Forward voltage	V_F	$I_F=10mA$			0.9	V
Clamping voltage	$V_C^{(2)}$	$I_{PP}=5A$			12	V
Junction capacitance	C_J	$V_R=0V, f=1MHz$		30	30	pF

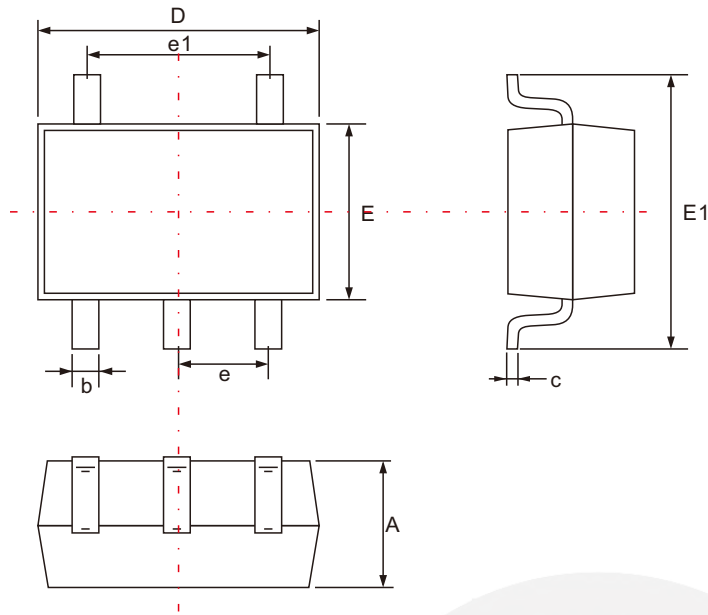
(1). Other voltages available upon request.

(2). Non-repetitive current pulse 8/20 μs exponential decay waveform according to IEC61000-4-5

Characteristic Curves



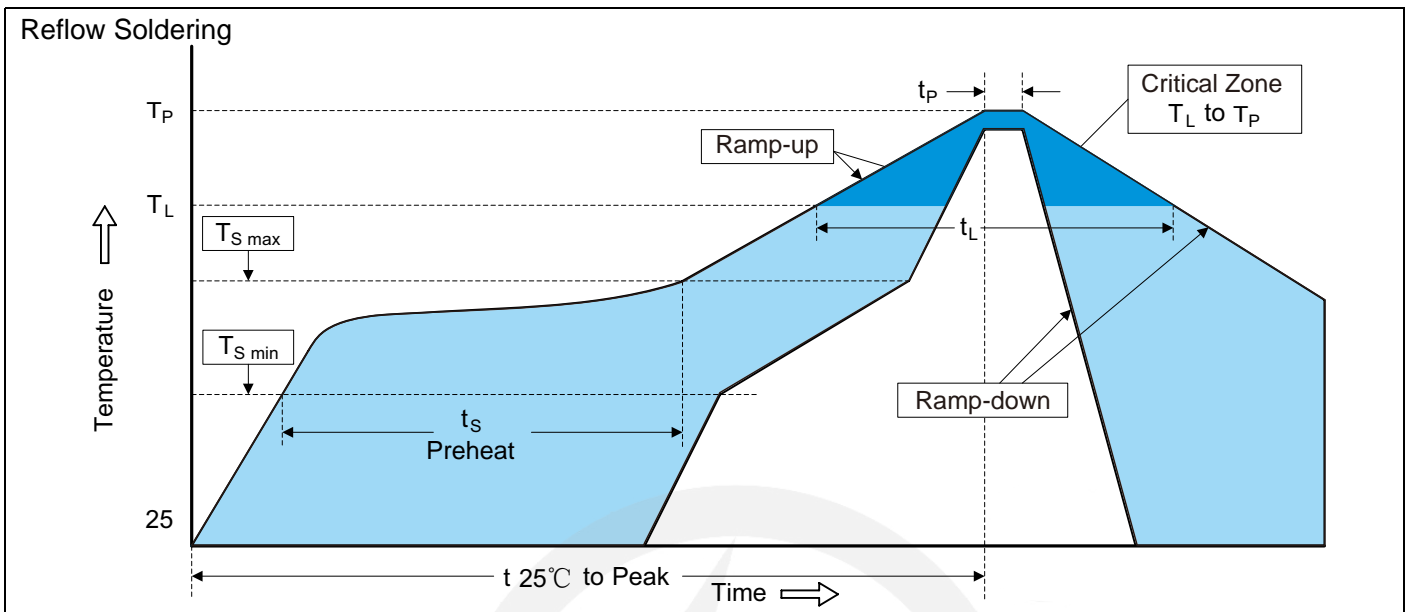
SOT-353 Package Outline



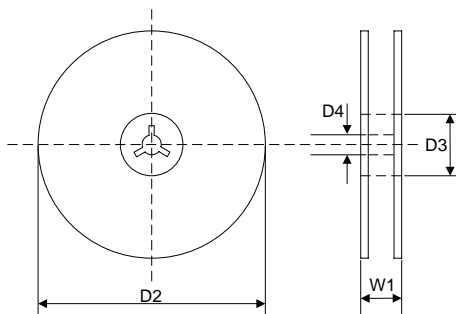
Unit: mm

SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	0.800	1.100
b	0.100	0.400
c	0.100	0.260
D	1.800	2.200
E	1.150	1.350
E1	2.000	2.500
e	0.650TYP.	
e1	1.200	1.400



Recommended Soldering Conditions

Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T_L to T_P)	3°C/second max.
Preheat -Temperature Min ($T_{S\ min}$) -Temperature Max ($T_{S\ max}$) -Time (min to max) (t_s)	150°C 200°C 60-180 seconds
$T_{S\ max}$ to T_L -Ramp-up Rate	3°C/second max.
Time maintained above: -Temperature (T_L) -Time (t_L)	217°C 60-150 seconds
Peak Temperature (T_P)	260°C
Time within 5°C of actual Peak Temperature (t_P)	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

7" Reel


D2	$\Phi 178.0 \pm 2.0$
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D3	$\Phi 50.0 \text{ Min.}$
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D4	$\Phi 13.0 \pm 0.5$
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W1	16.0 ± 2.0
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Quantity: 3000PCS